

BP22-30TD

Product Code: KRXP-2222xxHE9Ax

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REVISION HISTORY

Rev.	Date	Charged	Approved	Revision Summary
Α	2020/06/29	Fabien	Bruce	First issue



PRODUCT CHARACTERISTICS

1) Electrical characteristics

Characteristics	Min.	Тур.	Max.	Unit
Input Power (total)		200	280	W
Input Power Per Channel		100	140	W
DC Forward Current (total)		6.0	8.0	А
Forward Current Per Channel		3.0	4.0	А
DC Forward Voltage Per Channel		32	34	V
LED Junction Temperature		150		°C

2) Photometric characteristics

Characteristics	Min.	Тур.	Max.	Unit
CRI (Cool White / Warm White)	90			-
Luminous Flux (total)	•	17000	21000	lm
Luminous Flux of Cool White		10000	12000	lm
Luminous Flux of Warm White		7000	9000	lm
Light Emitting Surface (LES) Diameter		19.0		mm
Viewing Angle (FWHM)		120		degrees

JEDEC MOISTURE SENSITIVITY

Lovel	Floo	r Life
Level	Time	Conditions
1	unlimited	\leq 30°C / 85 % RH



BRIGHTNESS GROUPS

Item	Group Code	Measured Test Condition 3A Pulsed Operation Case Temperature T _c = 25°C Minimum Luminous Flux (Im) Cool Warm	
	B52	10000	7000
	B53	10000	8000
	B54	10000	9000
	B62	11000	7000
BP22-30TD	B63	11000	8000
	B64	11000	9000
	B72	12000	7000
	B73	12000	8000
	B74	12000	9000

Notes:

- GPI maintains a tolerance of ±7% on flux
- Calculated flux values are for reference only

PERFORMANCE GROUPS - CHROMATICITY

Color Code	Color	Mac Adam ellipse	Center x	Center y	a	b	theta
	050014	3-step	0.3123	0.3282	0.00669	0.00285	58.57
В	6500K	5-step	0.3123	0.3282	0.01115	0.00475	58.57

Color Code	Color	Mac Adam ellipse	Center x	Center y	а	b	theta
		3-step	0.4700	0.4300	0.0081	0.0042	53.7
Н	2600K	5-step	0.4700	0.4300	0.0135	0.0070	53.7

PERFORMANCE GROUPS - CHROMATICITY - CONTINUED

Croup Code	Chromaticity Region			
Group Code	Color 1	Color 2		
ВЦΛ	6500K	2600K		
ВНА	3-step	3-step		
DUD	6500K	2600K		
ВНВ	3-step	5-step		
ВНС	6500K	2600K		
ВПС	5-step	3-step		
BHD	6500K	2600K		
	5-step	5-step		



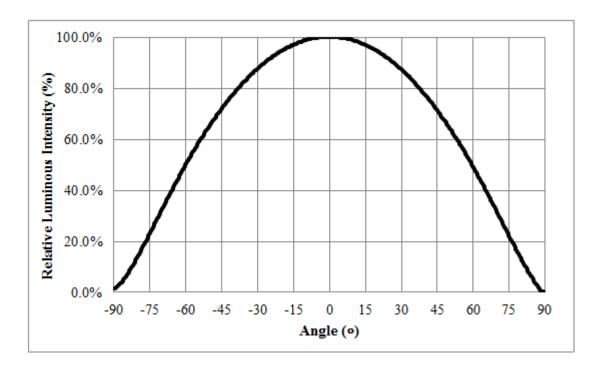
MAXIMUM RATINGS

Parameter		Values	Unit
Operating temperature range		-40 125	°C
Storage temperature range		-40 125	°C
Junction temperature	•	150	°C
Forward Current	(typ.)	3	А
(max.)		4	Α
Reversed voltage		not designed for reversed operation	V

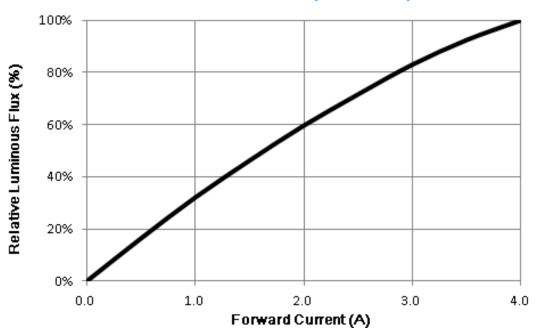
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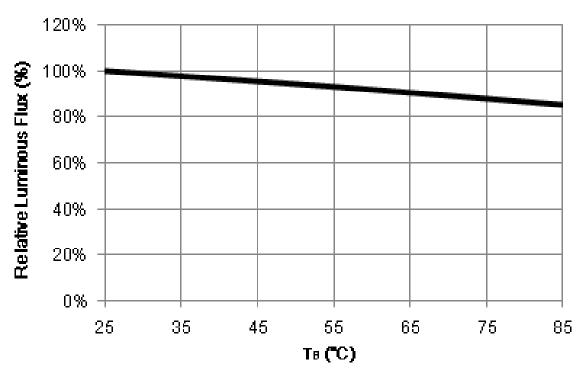
TYPICAL SPATIAL DISTRIBUTION



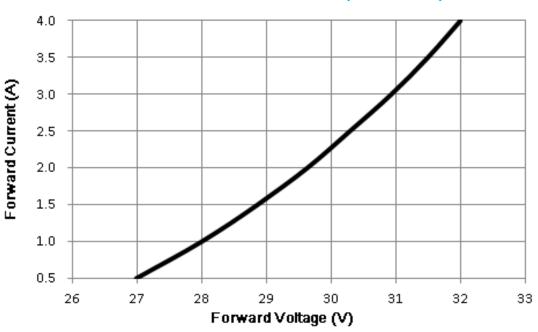
RELATIVE LUMINOUS FLUX VS. CURRENT ($T_B = 25$ °C)



RELATIVE LUMINOUS FLUX VS. TEMPERATURE ($I_F = 3A$)



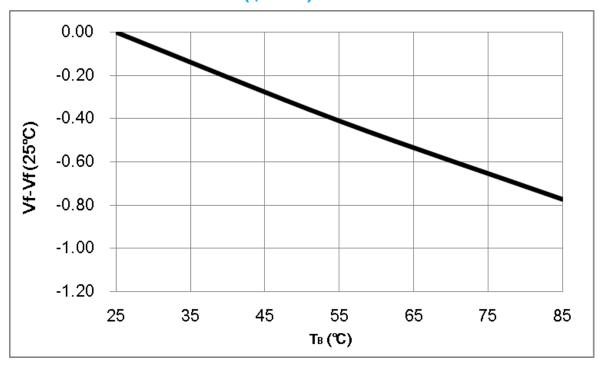
FORWARD VOLTAGE VS. FORWARD CURRENT (T_B = 25 °C)



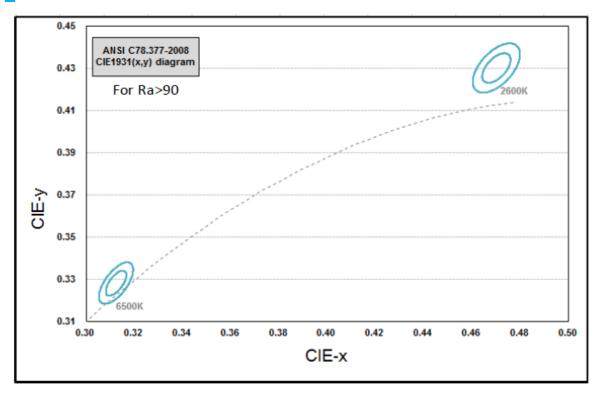
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RELATIVE FORWARD VOLTAGE ($I_F = 3A$)



GPI'S STANDARD WHITE CHROMATICITY REGINS PLOTTED ON THE 1931 CIE CURVE





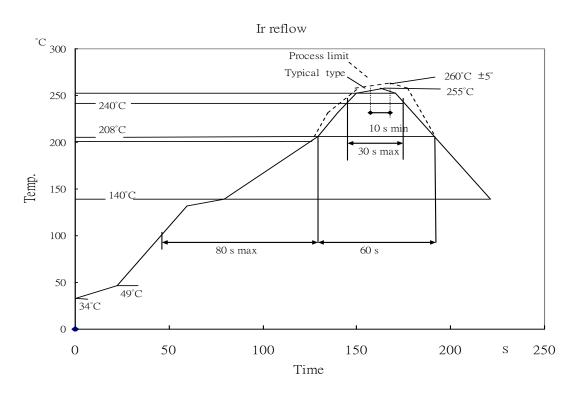
RELIABILITY

Test Item	Test Conditions	Test Period	Ac/Re
High Temperature Forward Bias (HTFB)	TA=85°C ; IF=3A DC	1000 hours	0/1
High Temperature High Humidity Bias (HTHHB)	TA=85°C;85% humidity IF=3A DC	1000 hours	0/1
Temperature Cycle (TC)	-40°C / 125°C 15min dwell, 5min transfer	1000 cycles	0/1

Notes:

- No catastrophic (LED Fail)
- Lumen maintenance > 85%
- Change in Vf < 10%
- Change in white color point $\Delta x \Delta y \pm 0.01$
- No corrosion
- Moisture Sensitivity Level 1 (IPC/JEDEC J-STD-020)

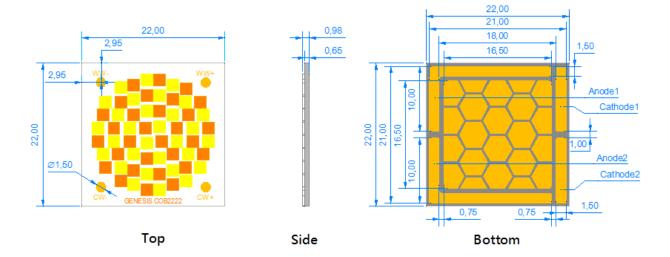
REFLOW SOLDERING CHARACTERISTICS

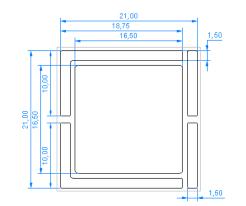




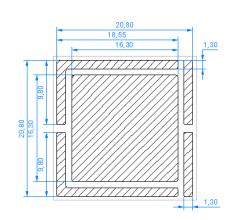
MECHANICAL DIMENSIONS

All measurements are ±.10 mm unless otherwise indicated.





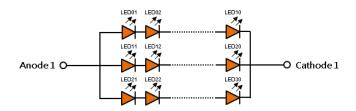
Recommended Soldering Pad Pattern

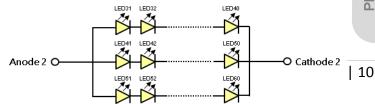


Recommended Metal Solder Stencil Aperture

Unit: mm

INTERNAL ELECTRICAL CIRCUIT





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CAUTIONS

1. Moisture Sensitivity

In testing, GPI has found BP22-30TD LEDs to have 1 year floor life in condition <=30C/85% relative humidity (RH). Moisture testing included a 168-hr soak at 85C/60% RH followed by 3 times reflow cycles, with visual and electrical inspections at each stage.

GPI recommends keeping BP22-30TD LEDs in their sealed moisture-barrier packaging until immediately prior to use. GPI also recommends returning any unusual LEDs to the re-sealable moisture-barrier bag and closing the bag immediately after use.

2. Handling Precautions

Do not handle LEDs with bare hands, it may contaminate the LED surface and affect optical characteristics. In the worst case, catastrophic failure from excess pressure through wire-bond breaks and package damage may result.

Do not stack assembled PCBs together. Failure to comply can cause the resin portion of the product to be cut, chipped, delaminated and/or deformed. It may cause wire to break, leading to catastrophic failures.

3. Eye safety

Warning: do not look at exposed lamp in operation. Eye injury can result.

4. Static Electricity

Wristbands and anti-electrostatic gloves are strongly recommended and all devices, equipment and machinery must be properly grounded when handling the LEDs, which are sensitive against static electricity and surge.

Precautions are to be taken against surge voltage to the equipment that mounts the LEDs. Unusual characteristics such as significant increase of current leakage, decrease of turn-on voltage or non-operation at a low current can occur when the LED is damaged.

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